

**10/576230**

PATENT APPLICATION

Express Mail Label No.: EV 7811732356 US **14 APR 2006**

IN THE U.S. PATENT AND TRADEMARK OFFICE

April 14, 2006

Applicants : Atsushi YABE et al

For : ELECTROLESS COPPER PLATING SOLUTION AND  
ELECTROLESS COPPER PLATING METHOD

PCT International Application No.: PCT/JP2004/014049

PCT International Filing Date: September 17, 2004

U.S. Application No.

(if known, see 37 CFR 1.5): Unknown

Atty. Docket No.: 4700.P0328US

Mail Stop PCT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT CANCELING CLAIMS**

Sir:

Prior to calculation of the filing fee in the above-  
identified application, kindly enter the following:

(Please see following pages.)